

1A, 400V - 600V Standard Surface Mount Rectifier

FEATURES

- Ideal for automated placement
- Low forward voltage drop
- Glass passivated chip junction
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- General purpose

MECHANICAL DATA

- Case: Micro SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.006g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	1	Α	
V_{RRM}	400 - 600	V	
I _{FSM}	20	Α	
T _{J MAX}	175	°C	
Package	Micro SMA		
Configuration	Single die		









Micro SMA



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	S1GM	S1JM	UNIT
Marking code on the device		A5	A7	
Repetitive peak reverse voltage	V_{RRM}	400	600	V
Reverse voltage, total rms value	$V_{R(RMS)}$	280	420	V
Forward current	I _F	,	1	А
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I _{FSM}	20		А
Junction temperature	T _J	-55 to +175		°C
Storage temperature	T _{STG}	-55 to +175		°C



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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	30	°C/W
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	110	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	I _F = 1A, T _J = 25°C	V _F	-	1.10	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C	I _R	-	1	μA
	T _J = 125°C		-	50	μA
Junction capacitance	1MHz, V _R = 4.0V	CJ	5	-	pF
Reverse recovery time	IF = 0.5A, IR = 1.0A Irr = 0.25A	t _{rr}	780	-	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING	
S1xM	Micro SMA	12,000 / Tape & Reel	

Notes:

1. "x" defines voltage from 400V(S1GM) to 600V(S1JM)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

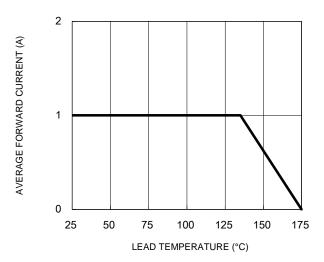


Fig.3 Typical Reverse Characteristics

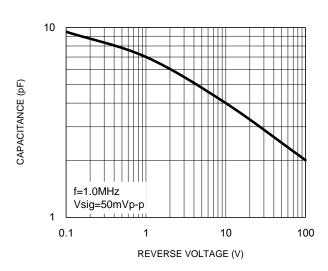
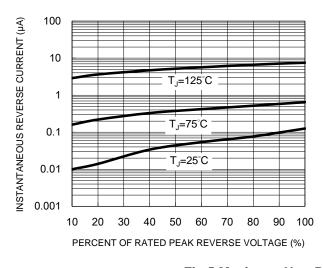


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



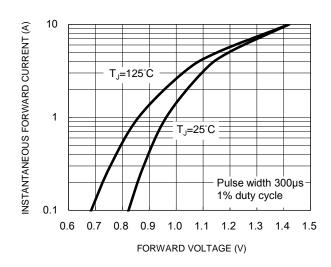
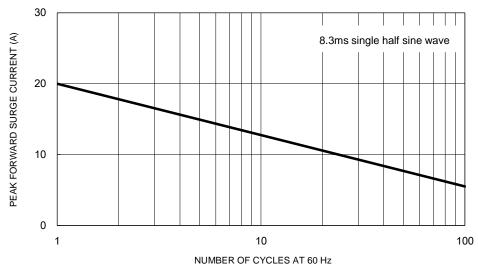


Fig.5 Maximum Non-Repetitive Forward Surge Current



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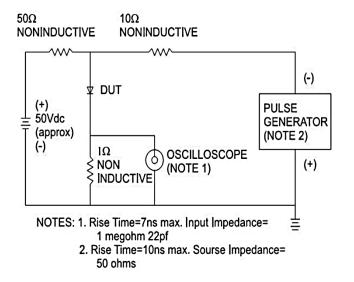


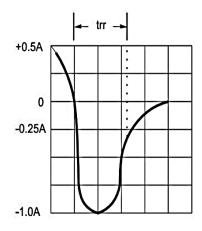


CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

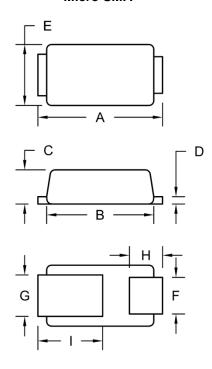






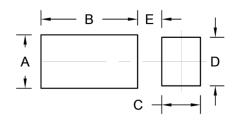
PACKAGE OUTLINE DIMENSIONS

Micro SMA



DIM.	Unit (mm)		Unit (Unit (inch)	
Dilvi.	Min.	Max.	Min.	Max.	
А	2.30	2.70	0.091	0.106	
В	2.10	2.30	0.083	0.091	
С	0.63	0.73	0.025	0.029	
D	0.10	0.20	0.004	0.008	
E	1.15	1.35	0.045	0.053	
F	0.65	0.85	0.026	0.034	
G	0.75	0.95	0.030	0.037	
Н	0.55	0.75	0.022	0.030	
I	1.10	1.50	0.043	0.059	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.10	0.043
В	2.00	0.079
С	0.80	0.031
D	1.00	0.039
E	0.50	0.020

MARKING DIAGRAM



P/N = Marking Code = Data Code ΥW



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